

Specification

Printed:
Revision:
(GB) Version:

SRC HM1 RMA T3 (Ag2) V16L

12.07.2012 06.07.2012 2.1

Trade Name: SRC HM1 RMA T3 (Ag2) V16L

1. Company Address: Almit GmbH Ph.: +49 6066 96884-0

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(DE) 64720 Michelstadt - near Frankfurt

2. Validity: This specification is specified for:

Almit-Solder-Paste SRC HM1 RMA T3 (Ag2) V16L

Delivered by Almit GmbH to: ______

3. Diameter & Allowance:

Weight	500g	500g	800g	1500g	0
Allowance		-	-0, +10g		

4. Deliverable Reel Size:

Metal Name	Solidus °C	Liquidus °C	Specific Gravity
Sn62 AG2	179	190	8.4

5. Physical Properties:

Test	Characteristics	Test Methods
Metal Content	90.5 ± 1.0	IPC-TM-650 2.2.20
Silver Chromate	pass	IPC-TM-650 2.3.33
Copper Mirror Test	pass	IPC-TM-650 2.3.32
SIR (85°C, 85%, 168hr) (Ω)	≥ 1x10 ⁸	IPC-TM-650 2.6.3.3
Corrosion Test	pass	IPC-TM-650 2.6.15
Flux materials composition	RO	J-STD 004 1.2
Quantitative Halide	L1 < 0.5%	IPC-TM-650 2.3.35
Fluorides By Spot Test	pass	IPC-TM-650 2.6.35.1

6. Characterisitcs:

Composition				(Components			
	Sn	Pb	Cu	Ag	Sb	Bi	Au	ln
Standard	62.0	Rest	≤0.05	2.0	≤0.12	≤0.1	≤0.08	≤0.1
Composition		Components						
	A	AI .	As	Cd	Fe	Ni	Zn	
Standard	≤0.	001	≤0.03	≤0.002	≤0.02	≤0.01	≤0.001	

7. Solder Powder Size & Distribuon:

% of Sample by Weight - Nominal Size

Туре	not larger than	Туре	less than 1% larger than	at least 80% between	at most 10% less than
Type 4 V1	L 40 Microns	4 V16L	38 Microns	20 - 38 Microns	20 Microns

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8. Lot-Size: A single lot contains 500kg which is the amount of one melting.

9. Quality and Inspecon:

Inspecon items are applied to each lot as follows:

	on items are applied to each	311101 4010110110	
Test No.	Inspection Item	Contents	Standard
1	Appearance	Color	Comparison with Limit Specimen
2	Weight	Net Weight	-0; +10 (g)
3	Solder Powder Size	20 - 38 μm V16L	94 ≤ (wt%)
		Pb	Rest (wt%)
4	4 Metal Composition	Sn	62.0 ± 0.5 (wt%)
4		Ag	2.0 ± 0.2 (wt%)
			(wt%)
5	7 Characteristics	Flux Content	9.5 ± 0.5 (wt%)
6		Solder Balling Test	Comparison with Limit Specimen
7		Viscosity (Spiral type, 10rpm, 25°C) (IPC-650-2.4.34.3)	230000 ± 30000 (cps) 230 ± 30 (Pa•s)
8		Solderability on Cu-Plate	Comparison with Limit Specimen
9		Dryness	Chalk powder should be easily removed from each test specimen.

^{*}Straight lines of solder paste are printed on a JIS-2 type substrate then reflowed. The reflowed solder is examined with a stereo microscope at 30X magnification. No more than 2 solder balls larger than one fifth the size of the pattern gap is allowed per gap.

10. Packing:

	Individual Package		Outer Package
Unit	Packing	Unit	Packing
500g	Polyethylene bottle	10kg ; 20kg	
500g	6 oz Catridge	10kg	
800g	Proflow Cassette	8kg; 16kg	Cardboard Box
1500g	18 oz Catridge	15kg	

11. Identification:

	Polyethylene bottle	Cardboard
Name	Almit-Solder-Paste SRC HM1 RMA T3 (Ag2) V16L	same as the left
Lot Nr.	(Ex.) 120119-9	dto.
Solder Powder Size	20 - 38 μm	dto.
Date of Mfg.	(Ex.) 19.01.2012	dto.
Net Weight	(Ex.) 500g	dto.
Maker	Nihon Almit Co. Ltd.	dto.

10. Maker Address: Nihon Almit Co. Ltd.

Almit Bldg., 2-14-2 Yayoicho, Nakano-ku, Tokyo, Japan

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11.	In case of changing t	his specification it should be accepted by:
	Signature	Date

12. This product is manufactured, using all guaranteed materials according to the legal law regulations.

13. Shelf Life:

Up to

6 month from the manufactured date (lot number).